

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:	)	PATENT APPLICATION
Inventor: Hirohiko Nishiki	)	
Serial No.: Not Yet Assigned	)	Attorney Docket No.
Filed: Herewith	)	SLA 0536
Title: STRUCTURE AND METHOD FOR SUPPORTING A FLEXIBLE SUBSTRATE	)	

1c971 U.S. PTO  
09/929708  
08/13/01

#2/IOS  
10/16/01  
C. McHunny

Hon. Assistant Commissioner for Patents  
Washington, D.C. 20231

**INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97**

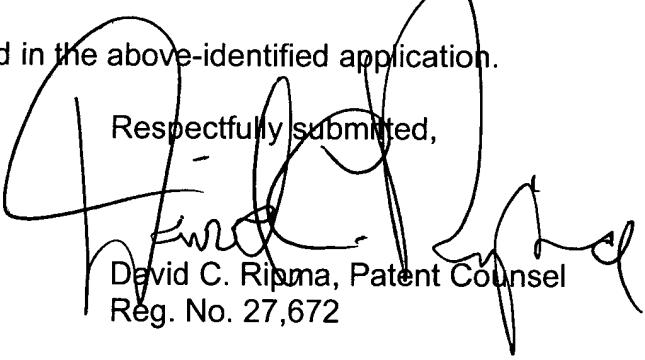
Sir:

Listed on attached Form PTO-1449 is information submitted pursuant to  
37 C.F.R. §1.56. A copy of each listed publication is submitted herewith.

Applicant respectfully requests that the listed information be considered by  
the Examiner and made of record in the above-identified application.

(Date) 8/13/01

Respectfully submitted,

  
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FORM PTO-1449			DOCKET NUMBER SLA536		APPLICATION NUMBER	
INFORMATION DISCLOSURE CITATION IN AN APPLICATION			APPLICANT Hirohiko Nishiki			
			FILING DATE: <i>08-13-01</i>		GROUP ART UNIT	
U.S. PATENT DOCUMENTS						
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FIL. DATE IF APPROP.
	5,699,139	12/16/97	Aastuen et al.	349	156	7/5/95
	6,214,460	4/10/01	Bluem et al.	428	355	11/12/96
FOREIGN PATENT DOCUMENTS						
	DOCUMENT NUMBER	DATE	COUNTRY/NAME	CLASS	SUB CLASS	TRANSLATION YES NO
OTHER DOCUMENTS						
	article entitled, "Tri-layer a-Si:H Integrated Circuits on Polymeric Substrates", by Thomasson et al., IEDM 98, pp. 253-256.					
EXAMINER			DATE CONSIDERED			